	Application Number		10568525	,
	Filing Date		2006-02-15	
INFORMATION DISCLOSURE	First Named Inventor Kashiwabara, et al.		wabara, et al.	
STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Art Unit		2879	
(NOt lot submission under 37 CFR 1.99)	Examiner Name	Maric	eli Santiago	
	Attorney Docket Numb	er	112857-517	

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Application Number	•	10568525	
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Art Unit		2879	
Examiner Name	Mario	celi Santiago	
Attorney Docket Number		112857-517	

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Atty Docket No. 112857-517	Application No. 568		
Applicant Kashiwabara et al.	Date Submitted 02-15-2006		
Filing Date 02-15-2006	Group Unknown		

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